











DRV3202-Q1

SLVSBJ4B-OCTOBER 2012-REVISED JULY 2016

# DRV3202-Q1 3-Phase Brushless Motor Driver

Not Recommended for New Designs

### **Features**

- 3-Phase Pre-drivers for N-channel MOS Field Effect Transistors (MOSFETs)
- Pulse Width Modulation (PWM) Frequency up to 20 kHz
- **Fault Diagnostics**
- Charge Pump
- **Phase Comparators**
- Phase Monitoring Sample and Hold Op-Amps
- Central Processing Unit (CPU) Reset Generator
- Serial Port I/F (SPI)
- Motor Current Sense
- 80-pin HTQFP
- Controller Area Network (CAN)
- 5-V Regulator

# **Applications**

Automotive

# 3 Description

The DRV3202-Q1 device is a field effect transistor (FET) pre-driver designed for 3-phase motor control and its application such as an oil pump or a water pump. It is equipped with three high-side pre-FET drivers and three low-side drivers which are controlled by an external microcontroller (MCU). The power for the high side is supplied by a charge pump and no bootstrap cap is needed. For commutation, this integrated circuit (IC) sends a conditional motor drive signal and output to the MCU. Diagnostics undervoltage, overvoltage, overcurrent, overtemperature and power bridge faults. The motor current can be measured using an integrated current sense amplifier and comparator in a battery commonmode range, which allows the motor current to be used in a high-side current sense application. Gain is attained by external resistors. If the MCU does not have enough bandwidth, the phase monitoring sample and hold amplifiers can hold phase information until the MCU is ready to process it. The interfaces include SPI and CAN. The pre-driver and other internal settings can be configured through the SPI. The CAN is used to communicate with other electronic control units (ECUs).

#### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
DRV3202-Q1	HTQFP (80)	12.00 mm × 12.00 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.



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7	Detailed Description 19		Information	>:

### 4 Revision history

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

### Changes from Revision A (December 2012) to Revision B

**Page** 

Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functional Modes, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section ..... 1 

# Changes from Original (October, 2012) to Revision A

**Page** 

•	Changed O to IO for pin 44 and 45	. 5
•	Deleted Table 1 Pin Equivalent Circuits.	. 6
•	Changed VCANH and VCANL to VCAN_H and VCAN_L in CAN receiver section	. 7
•	Added 3 new parameters to VCC and VDD Electrical Characteristics table. Changed min, typ, and max values VLRVCC, CVCC, TVCC1, TVCC2, VDDOV, TVDD. Added table note.	. 8
•	Changed VCANH and VCANL to VCAN_H and VCAN_L in CAN AC characteristic section	. 8
•	Changed CANH_D to VCANH_D, CANL_D to VCANL_D, and VCANH - VCANL to VCAN_H - VCAN_L in CAN timing chart.	. 8
•	Changed $V_{chv1\_12}$ to $V_{chv1\_1}$ , $V_{chv1\_20}$ to $V_{chv1\_2}$ , $V_{chv2\_12}$ to $V_{chv2\_1}$ , $V_{chv2\_20}$ to $V_{chv2\_2}$ , $V_{chv3\_12}$ to $V_{chv3\_1}$ , $V_{chv3\_20}$ to $V_{chv3\_2}$ .	. 9
•	Added min and typ values to V <sub>chvmax</sub> parameter	. 9
•	Changed min, typ and max values for V <sub>chv1_0</sub> through V <sub>chv3_2</sub> ; changed typ R <sub>on</sub> value from 10 to 8	. 9

Changed max rating for PHTM, PH1M, PH2M, and PH3M from -2 -40 V to -1-40 V.

Removed R<sub>ONH\_H</sub> row, removed cross-references from R<sub>ONH\_HP</sub> and R<sub>ONH\_HP</sub>, added conditions to R<sub>ONH\_HP</sub> and R<sub>ONH\_HN</sub>, changed typ and max values for R<sub>ONH\_HN</sub>. 9 Removed "side" from  $V_{\text{OH\_L}}$  and  $V_{\text{OL\_L}}$  description, changed high side and low side to pull up and pull down respectively for R<sub>ONL\_L</sub> and R<sub>ONL\_L</sub>. Changed values for R<sub>ONL\_L</sub> from 10 typ to 7 typ and from 20 max to 14 max in

- Added C1 = 4.7 pF to  $T_{\text{set\_TR1}}$ ,  $T_{\text{set\_TR2}}$ ,  $T_{\text{set\_TF1}}$ , and  $T_{\text{set\_TF2}}$  conditions in motor current sense electrical characteristics... 10
- Changed max current limit from 500 to 550.

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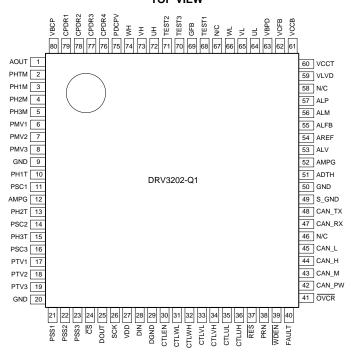
Changed CANTX to CAN_TX and CANH and CANL to CAN_H and CAN_L in CAN reset function image	. 15
CAN_H, CAN_L, and CAN_M in block diagram	. 22
Changed charge pump description	. 22
Changed pre-driver description and updated block diagram	. 23
Updated phase comparator description.	. 24
Changed motor current sense description and motor current sense block diagram	. 25
Updated Sample and Hold Mode Block Diagram	. 25
Changed V <sub>CC</sub> Block Diagram	. 27
Changed VB Monitor description	. 28
Changed thermal shutdown description.	. 29
Changed location of EN in Figure 34.	. 30
Changed MCU RESET column to RES column; changed values	. 31
	Changed CANH and CANL to CAN_H and CAN_L in description section; changed CANH, CANL, and CANM to CAN_H, CAN_L, and CAN_M in block diagram  Changed charge pump description  Changed pre-driver description and updated block diagram  Updated phase comparator description  Changed motor current sense description and motor current sense block diagram  Updated Sample and Hold Mode Block Diagram  Changed V <sub>CC</sub> Block Diagram  Changed VB Monitor description  Changed thermal shutdown description.  Changed location of EN in Figure 34.

Product Folder Links: DRV3202-Q1



# 5 Pin Configuration and Functions

#### PFP PACKAGE 80-PINS HTQFP TOP VIEW



### **Pin Functions**

			Г	'in Functions
	PIN		MAX RATING	FUNCTION
NO.	NAME	TYPE	WAX KATING	FUNCTION
1	AOUT	0	-0.3-6 V	Test mode output
2	PHTM	I	-1-40 V	Phase comparator reference input
3	PH1M	I	-1-40 V	Phase comparator input
4	PH2M	I	-1-40 V	Phase comparator input
5	РНЗМ	1	-1-40 V	Phase comparator input
6	PMV1	0	-0.3-6 V	Phase comparator output
7	PMV2	0	-0.3-6 V	Phase comparator output
8	PMV3	0	-0.3-6 V	Phase comparator output
9, 20, 50	GND	I	-0.3-0.3 V	GND
10	PH1T	1	-2-40 V	Phase amplifier input
11	PSC1	0	-0.3-6 V	Sample and hold filter output
12	AMPG	I	-0.3-0.3 V	Quiet GND
13	PH2T	I	-2-40 V	Phase amplifier input
14	PSC2	0	-0.3-6 V	Sample and hold filter output
15	PH3T	I	-2-40 V	Phase amplifier input
16	PSC3	0	-0.3-6 V	Sample and hold filter output
17	PTV1	0	-0.3-6 V	Phase amplifier output
18	PTV2	0	-0.3-6 V	Phase amplifier output
19	PTV3	0	-0.3-6 V	Phase amplifier output
21	PSS1	1	-0.3-6 V	Sample and hold control signal input
22	PSS2	1	-0.3-6 V	Sample and hold control signal input
23	PSS3	I	-0.3-6 V	Sample and hold control signal input

Submit Documentation Feedback

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# Pin Functions (continued)

NO.         NAME         TYPE         MAX RATING         FUNCTION           24         CS         I         -0.3-6 V         SPI chip select           25         DOUT         O         -0.3-6 V         SPI clada output           26         SCK         I         -0.3-6 V         SPI clada input           27         VDD         O         -0.3-6 V         SPI clada input           28         DIN         I         -0.3-6 V         SPI clada input           29         DGND         I         -0.3-6 V         Pre-driver parallel input           30         CTLWH         I         -0.3-6 V         Pre-driver parallel input           31         CTLWH         I         -0.3-6 V         Pre-driver parallel input           33         CTLUL         I         -0.3-6 V         Pre-driver parallel input           34         CTLUL         I         -0.3-6 V         Pre-driver parallel input           35         CTLUL         I         -0.3-6 V         Pre-driver parallel input           36         CTLUH         I         -0.3-6 V         Pre-driver parallel input           37         RES         O         -0.3-6 V         Pre-driver parallel input		PIN			
24	NO.		TYPE	MAX RATING	FUNCTION
25			ı	-0.3-6 V	SPI chip select
26         SCK         I         -0.3-6 V         SPI clock           27         VDD         O         -0.3-36 V         Digital supply output           28         DIN         I         -0.3-6 V         SPI data input           29         DGND         I         -0.3-6 V         Pre-driver parallel enable input           30         CTLEN         I         -0.3-6 V         Pre-driver parallel input           31         CTLWL         I         -0.3-6 V         Pre-driver parallel input           32         CTLWL         I         -0.3-6 V         Pre-driver parallel input           33         CTLVL         I         -0.3-6 V         Pre-driver parallel input           34         CTLUH         I         -0.3-6 V         Pre-driver parallel input           36         CTLUH         I         -0.3-6 V         Pre-driver parallel input           37         RES         O         -0.3-6 V         Pre-driver parallel input           39         WDEN         I         -0.3-6 V         Pre-driver parallel input           40         FALLT         I         -0.3-6 V         Pre-driver parallel input           41         OXDEN         RES         O         -0.3-6 V         <	25		0	-0.3-6 V	,
28	26	SCK	ı	-0.3-6 V	· ·
28			0		
29					
30			1		·
STEAM   CTLWL   1			1		
32         CTLWH         I         -0.3-6 V         Pre-driver parallel input           33         CTLVL         I         -0.3-6 V         Pre-driver parallel input           34         CTLVH         I         -0.3-6 V         Pre-driver parallel input           35         CTLUH         I         -0.3-6 V         Pre-driver parallel input           36         CTLUH         I         -0.3-6 V         Pre-driver parallel input           37         RES         O         -0.3-6 V         Reset output           39         WDEN         I         -0.3-6 V         Pulse input           40         FAULT         O         -0.3-6 V         Reset generator enable input           41         OVCR         I         -0.3-6 V         Desprise output           41         OVCR         I         -0.3-6 V         Over current reset input           42         CAN_PW         I         -0.3-6 V         Over current reset input           43         CAN_H         IO         -27-40 V         CAN supply input           44         CAN_H         IO         -27-40 V         CAN transceiver middle point terminal           45         CAN_L         IO         -27-40 V         CAN transceiver neg			<u> </u>		
33         CTLVL         I         -0.3-6 V         Pre-driver parallel input           34         CTLVH         I         -0.3-6 V         Pre-driver parallel input           35         CTLUL         I         -0.3-6 V         Pre-driver parallel input           36         CTLUH         I         -0.3-6 V         Pre-driver parallel input           37         RES         O         -0.3-6 V         Reset output           38         PRN         I         -0.3-6 V         Reset generator enable input           40         FAULT         O         -0.3-6 V         Reset generator enable input           41         ÖVCR         I         -0.3-6 V         Diagnosis output           41         ÖVCR         I         -0.3-6 V         Over current reset input           42         CAN_PW         I         -0.3-6 V         CAN supply input           43         CAN_H         IO         -27-40 V         CAN transceiver middle point terminal           44         CAN_H         IO         -27-40 V         CAN transceiver mositive terminal           45         CAN_H         IO         -27-40 V         CAN transceiver mositive terminal           46         SB, 67         N/C         N/C			1		
34         CTLVH         I         -0.3-6 V         Pre-driver parallel input           35         CTLUH         I         -0.3-6 V         Pre-driver parallel input           36         CTLUH         I         -0.3-6 V         Pre-driver parallel input           37         RES         O         -0.3-6 V         Reset output           38         PRN         I         -0.3-6 V         Pulse input           39         WDEN         I         -0.3-6 V         Reset generator enable input           40         FAULT         O         -0.3-6 V         Diagnosis output           41         ÖVCR         I         -0.3-6 V         Diagnosis output           41         ÖVCR         I         -0.3-6 V         Over current reset input           42         CAN_PW         I         -0.3-6 V         CAN tansceiver middle point terminal           43         CAN_M         O         -27-40 V         CAN transceiver megative terminal           44         CAN_H         IO         -27-40 V         CAN transceiver negative terminal           45         CAN_L         IO         -27-40 V         CAN transceiver negative terminal           46         CAN_TX         I         -0.3-6 V			1		
35         CTLUL         I         -0.3-6 V         Pre-driver parallel input           36         CTLUH         I         -0.3-6 V         Pre-driver parallel input           37         RES         O         -0.3-6 V         Reset output           38         PRN         I         -0.3-6 V         Pulse input           39         WDEN         I         -0.3-6 V         Reset generator enable input           40         FAULT         O         -0.3-6 V         Diagnosis output           41         ÖVCR         I         -0.3-6 V         Over current reset input           42         CAN_PW         I         -0.3-6 V         CAN supply input           43         CAN_M         O         -27-40 V         CAN transceiver positive terminal           44         CAN_H         IO         -27-40 V         CAN transceiver positive terminal           45         CAN_L         IO         -27-40 V         CAN transceiver positive terminal           45         CAN_L         IO         -27-40 V         CAN transceiver positive terminal           46         S.B, 67         N/C         —         —         Not connected           47         CAN_EX         O         -0.3-6 V			1		
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38					
39   WDEN					
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44         CAN_H         IO         -27-40 V         CAN transceiver positive terminal           45         CAN_L         IO         -27-40 V         CAN transceiver negative terminal           46, 58, 67         N/C         —         Not connected           47         CAN_RX         O         -0.3-6 V         CAN digital output           48         CAN_TX         I         -0.3-6 V         CAN digital input           49         S_GND         I         -0.3-6 V         Motor overcurrent threshold input           51         ADTH         I         -0.3-6 V         Motor overcurrent threshold input           52         AMPG         I         -0.3-6 V         Motor current sense amp output           53         ALV         O         -0.3-6 V         Motor current sense amp output           54         AREF         O         -0.3-40 V         Motor current sense amp feedback           55         ALFB         O         -0.3-40 V         Motor current sense amp negative input           57         ALP         I         -0.3-40 V         Motor current sense amp positive input           59         VLVD         I         -0.3-6 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT					
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48         CAN_TX         I         -0.3-6 V         CAN digital input           49         S_GND         I         -0.3-0.3 V         CAN GND           51         ADTH         I         -0.3-6 V         Motor overcurrent threshold input           52         AMPG         I         -0.3-6 V         Quiet GND           53         ALV         O         -0.3-6 V         Motor current sense amp output           54         AREF         O         -0.3-40 V         Motor current sense reference output           55         ALFB         O         -0.3-40 V         Motor current sense amp feedback           56         ALM         I         -0.3-40 V         Motor current sense amp positive input           57         ALP         I         -0.3-40 V         Motor current sense amp positive input           59         VLVD         I         -0.3-6 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VB			0	-0.3-6 V	
49         S_GND         I         -0.3-6 V         Motor overcurrent threshold input           51         ADTH         I         -0.3-6 V         Motor overcurrent threshold input           52         AMPG         I         -0.3-0.3 V         Quiet GND           53         ALV         O         -0.3-6 V         Motor current sense amp output           54         AREF         O         -0.3-40 V         Motor current sense reference output           55         ALFB         O         -0.3-40 V         Motor current sense amp feedback           56         ALM         I         -0.3-40 V         Motor current sense amp negative input           57         ALP         I         -0.3-40 V         Motor current sense amp positive input           59         VLVD         I         -0.3-6 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>C</sub> regulator current sense input           63         VBPD         I         -0.3-20 V         Pre-driver output <t< td=""><td></td><td></td><td></td><td></td><td></td></t<>					
51         ADTH         I         -0.3-6 V         Motor overcurrent threshold input           52         AMPG         I         -0.3-0.3 V         Quiet GND           53         ALV         O         -0.3-6 V         Motor current sense amp output           54         AREF         O         -0.3-40 V         Motor current sense reference output           55         ALFB         O         -0.3-40 V         Motor current sense amp feedback           56         ALM         I         -0.3-40 V         Motor current sense amp negative input           57         ALP         I         -0.3-40 V         Motor current sense amp positive input           59         VLVD         I         -0.3-6 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           66         WL </td <td></td> <td></td> <td></td> <td></td> <td></td>					
52         AMPG         I         -0.3-0.3 V         Quiet GND           53         ALV         O         -0.3-6 V         Motor current sense amp output           54         AREF         O         -0.3-40 V         Motor current sense reference output           55         ALFB         O         -0.3-40 V         Motor current sense amp feedback           56         ALM         I         -0.3-40 V         Motor current sense amp negative input           57         ALP         I         -0.3-40 V         Motor current sense amp positive input           59         VLVD         I         -0.3-40 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           65         VL         O         -0.3-20 V         Pre-driver output			•		
53         ALV         O         -0.3-6 V         Motor current sense amp output           54         AREF         O         -0.3-40 V         Motor current sense reference output           55         ALFB         O         -0.3-40 V         Motor current sense amp feedback           56         ALM         I         -0.3-40 V         Motor current sense amp negative input           57         ALP         I         -0.3-40 V         Motor current sense amp positive input           59         VLVD         I         -0.3-6 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           65         VL         O         -0.3-20 V         Pre-driver output			-		
54         AREF         O         -0.3-40 V         Motor current sense reference output           55         ALFB         O         -0.3-40 V         Motor current sense amp feedback           56         ALM         I         -0.3-40 V         Motor current sense amp negative input           57         ALP         I         -0.3-40 V         Motor current sense amp positive input           59         VLVD         I         -0.3-6 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           65         VL         O         -0.3-20 V         Pre-driver output           66         WL         O         -0.3-20 V         Pre-driver output			•		
55         ALFB         O         -0.3-40 V         Motor current sense amp feedback           56         ALM         I         -0.3-40 V         Motor current sense amp negative input           57         ALP         I         -0.3-40 V         Motor current sense amp positive input           59         VLVD         I         -0.3-6 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           65         VL         O         -0.3-20 V         Pre-driver output           66         WL         O         -0.3-20 V         Pre-driver output					` '
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57         ALP         I         -0.3-40 V         Motor current sense amp positive input           59         VLVD         I         -0.3-6 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           65         VL         O         -0.3-20 V         Pre-driver output           66         WL         O         -0.3-20 V         Pre-driver output					'
59         VLVD         I         -0.3-6 V         V <sub>CC</sub> undervoltage threshold input           60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           65         VL         O         -0.3-20 V         Pre-driver output           66         WL         O         -0.3-20 V         Pre-driver output					
60         VCCT         I         -0.3-6 V         V <sub>CC</sub> supply input           61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           65         VL         O         -0.3-20 V         Pre-driver output           66         WL         O         -0.3-20 V         Pre-driver output			-		
61         VCCB         O         -0.3-40 V         V <sub>CC</sub> regulator base drive for PNP external transistor           62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           65         VL         O         -0.3-20 V         Pre-driver output           66         WL         O         -0.3-20 V         Pre-driver output			1		
62         VCFB         I         -0.3-40 V         V <sub>CC</sub> regulator current sense input           63         VBPD         I         -0.3-40 V         VB input           64         UL         O         -0.3-20 V         Pre-driver output           65         VL         O         -0.3-20 V         Pre-driver output           66         WL         O         -0.3-20 V         Pre-driver output		_	0		
63       VBPD       I       -0.3-40 V       VB input         64       UL       O       -0.3-20 V       Pre-driver output         65       VL       O       -0.3-20 V       Pre-driver output         66       WL       O       -0.3-20 V       Pre-driver output			1		
64         UL         O         -0.3–20 V         Pre-driver output           65         VL         O         -0.3–20 V         Pre-driver output           66         WL         O         -0.3–20 V         Pre-driver output			I		
65 VL O -0.3–20 V Pre-driver output 66 WL O -0.3–20 V Pre-driver output			•		
66 WL O -0.3–20 V Pre-driver output		_			·
68     IES [1         -0.3-6 V   Test input	68	TEST1	ı	-0.3-6 V	Test input
69 GFB I -0.3-0.3 V Power GND			ı		-
70 TEST3 I -0.3-20 V Test input			•		
71 TEST2 I -0.3-6 V Test input		_	•		
72 UH O -0.3-40 V Pre-driver output		_	0		

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## Pin Functions (continued)

PIN		MAY DATING	FUNCTION		
NO.	NAME	TYPE	MAX RATING	FUNCTION	
73	VH	0	-0.3-40 V	Pre-driver output	
74	WH	0	-0.3-40 V	Pre-driver output	
75	PDCPV	0	-0.3-40 V	Charge pump output	
76	CPDR4	0	-0.3-40 V	Charge pump output	
77	CPDR3	0	-0.3-40 V	Charge pump output	
78	CPDR2	0	-0.3-40 V	Charge pump output	
79	CPDR1	0	-0.3-40 V	Charge pump output	
80	VBCP	I	-0.3-4 0V	VB input	

# 6 Specifications

# 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
T <sub>A</sub>	Operating temperature range	-40	125	degree
$T_J$	Junction temperature	-40	150	degree
Ts	Storage temperature	-55	150	degree

# 6.2 ESD Ratings

			VALUE	UNIT
.,	Florence to the dischause (1)	Human-body model (HBM)	±2000	V
V(ESD)	V <sub>(ESD)</sub> Electrostatic discharge <sup>(1)</sup>	Charged-device model (CDM)	±500	V

<sup>(1)</sup> ESD testing is performed according to the ACE-Q100 standard.

### 6.3 Thermal Information

		DRV3202-Q1	
	THERMAL METRIC <sup>(1)</sup>	PFP (HTQFP )	UNIT
		80 PINS	
$\theta_{JA}$	Junction-to-ambient thermal resistance	23.0	°C/W
$\theta_{JCtop}$	Junction-to-case (top) thermal resistance	7.5	°C/W
$\theta_{JB}$	Junction-to-board thermal resistance	7.6	°C/W
ΨЈТ	Junction-to-top characterization parameter	0.2	°C/W
ΨЈВ	Junction-to-board characterization parameter	7.4	°C/W
$\theta_{\text{JCbot}}$	Junction-to-case (bottom) thermal resistance	0.3	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

Product Folder Links: DRV3202-Q1



# 6.4 Electrical Characteristics

 $VB = 12 \text{ V}, T_{\Delta} = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  (unless otherwise specified)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
WATCHDO	G					
VSTN	Function start V <sub>CC</sub> voltage RES			0.8	1.3	V
t <sub>ON</sub>	Power-on time RES		32	40	48	ms
t <sub>OFF</sub>	Clock off reset time RES		64	80	96	ms
t <sub>RL</sub>	Reset pulse low time RES	Refer to Figure 1	16	20	24	ms
t <sub>RH</sub>	Reset pulse high time RES		64	80	96	ms
t <sub>RES</sub>	Reset delay time RES		30	71.5	90	μs
P <sub>wth</sub>	Pulse width PRN		200	_	-	ns
SPI						
F <sub>op</sub>	Operating frequency		DC	_	4	MHz
T <sub>lead</sub>	Enable lead time		100	-	-	ns
T <sub>wait</sub>	Wait time between two successive communications		5	-	-	μs
T <sub>lag</sub>	Enable lag time	Refer to Figure 2	100	-	_	ns
T <sub>pw</sub>	SCLK pulse width		100	_	-	ns
T <sub>su</sub>	Data setup time		80	_	_	ns
T <sub>h</sub>	Data hold time		80	_	_	ns
T <sub>dis</sub>	Disable time		-	-	80	ns
T <sub>del</sub>	Data delay time (SCK to DOUT)	C <sub>L</sub> = 50 pF, Refer to Figure 2	-	-	80	ns
CAN (TRAN	ISMITTER SECTION)					
VCAN_H	Pue veltage recessive		2	2.5	3	V
VCAN_L	Bus voltage recessive		2	2.5	3	V
VDIFF = (VCAN_H	Differential output voltage	$CAN_TX = V_{CC}$ , $I_{CANH} = I_{CANL} = 0$ , see Figure 3	-500	0	50	mV
VCAN_L)						
VCAN_H	Bus voltage recessive 2	CAN H and CAN L and Figure 3	2.25	2.5	2.75	V
VCAN_L	Bus voltage recessive 2	CAN_H and CAN_L, see Figure 3 and Figure 4	2.25	2.5	2.75	V
VCANH_D	Dominant state CAN_H output voltage	CAN_TX = 0 V, $R_L = 60 \Omega$ between	2.75	3.5	4.5	V
VCANL_D	Dominant state CAN_L output voltage	CAN_H and CAN_L, see Figure 3	0.5	1.5	2.25	V
VDIFF = (VCANH_ D - VCANL_D)	Differential output voltage	CAN_TX = 0 V, R <sub>L</sub> = 60 $\Omega$ between CAN_H and CAN_L	1.5	2	3	V
IA_CANH	CAN_H short circuit threshold current	CAN_TX = 0 V	70	-	160	mA
IA_CANL	CAN_L short circuit threshold current	CAN_TX = 0 V	70	-	160	mA
t <sub>OVCAN</sub>	Overcurrent to output switch-off delay	Refer to Figure 6	200			ns
T <sub>RESCAN</sub>	Self recovery time	Refer to Figure 6	8	25	50	μs
	IVER SECTION)				,	
$V_{DOM}$	Differential input voltage for dominant state (VDIFF = VCAN_H - VCAN_L)	VCAN_L = -12 V to 12 V, CAN_TX = V <sub>CC</sub>	900			mV
V <sub>REC</sub>	Differential input voltage for recessive state (VDIFF = VCAN_H – VCAN_L)	VCAN_L = -12 V to 12 V, CAN_TX = V <sub>CC</sub>			500	mV
V <sub>hys</sub>	Differential input hysteresis		80	150	_	mV
,	<del>-</del>	1				

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# **Electrical Characteristics (continued)**

VB = 12 V,  $T_A = -40$ °C to 125°C (unless otherwise specified)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>com</sub> = (VCAN_H - VCAN_L) / 2	Input common mode voltage range		-12	-	12	V
R <sub>IN</sub>	Input resistance CAN_H, CAN_L	$CAN_TX = V_{CC}$	5	-	50	$k\Omega$
R <sub>DIFF</sub>	Differential input resistance	$CAN_TX = V_{CC}$	10	-	100	$k\Omega$
C <sub>IN</sub> <sup>(1)</sup>	Input capacitance to ground CAN_H, CAN_L	CAN_TX = V <sub>CC</sub>	_	20	46	pF
C <sub>DIFF</sub> <sup>(1)</sup>	Differential input capacitance to ground	CAN_TX = V <sub>CC</sub>	_	10	-	pF
C <sub>IN</sub> <sup>(1)</sup>	Input capacitance between CAN_H and CAN_L	CAN_TX = V <sub>CC</sub>	-	-	46	pF
CAN (AC C	HARACTERISTIC)					
t <sub>TDhHS</sub>	Delay time from CAN_TX to VDIFF = VCAN_H - VCAN_L	Refer to Figure 3	_	-	100	ns
t <sub>TDIHS</sub>		Refer to Figure 3	_	_	100	ns
t <sub>DRHS</sub>	Delay time from VDIFF = VCAN_H - VCAN_L to CAN_RX	Refer to Figure 3	_	-	150	ns
t <sub>TRIHS</sub>	Delay time from CAN_TX to CAN_RX	Refer to Figure 3	_	-	300	ns
t <sub>TRhHS</sub>		Refer to Figure 3	_	_	300	ns
SRHS_R	Slew rate, CAN_H, rise	Threshold set to 20%-80%		20	85	ns
SRHS_F	Slew rate, CAN_H, fall	Threshold set to 80%-20%		20	85	ns
SRLS_R	Slew rate, CAN_L, rise	Threshold set to 20%-80%		20	85	ns
SRLS_F	Slew rate, CAN_L, fall	Threshold set to 80%-20%		20	85	ns
CAN (SPLI	Γ, OPTIONAL)					
VCAN_M_I	Output voltage	I <sub>source</sub> , I <sub>sink</sub> = 500 μA	0.3	0.5	0.7	V <sub>CC</sub>
VCAN_M_ u	Output voltage, unloaded condition	$R_{measure} > 1 M\Omega$	0.45	0.5	0.55	V <sub>CC</sub>
CAN (POW	ER OFF CONDITION)					
R <sub>IN</sub>	Input resistance CAN_H, CAN_L	VB = 0 V	10	_	100	kΩ

<sup>(1)</sup> Specified by design

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# **Electrical Characteristics (continued)**

 $VB = 12 \text{ V}, T_{\Delta} = -40 ^{\circ}\text{C}$  to  $125 ^{\circ}\text{C}$  (unless otherwise specified)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
CHARGE	PUMP <sup>(1)</sup>		•			
V <sub>chv1_0</sub>		$VB = 5.3 \text{ V}, I_{load} = 0 \text{ mA}, C1 = C2 = 47 \text{ nF}, CCP = 2.2 \mu\text{F}$	VB + 7	VB + 8	VB + 9	V
V <sub>chv1_1</sub>		VB = 5.3 V, $I_{load}$ = 5 mA, C1 = C2 = 47 nF, CCP = 2.2 $\mu$ F	VB + 6	VB + 7	VB + 8	V
V <sub>chv1_2</sub>		VB = 5.3 V, $I_{load}$ = 8 mA, C1 = C2 = 47 nF, CCP = 2.2 $\mu$ F	VB + 5	VB + 6	VB + 7	V
V <sub>chv2_0</sub>		VB = 12 V, $I_{load}$ = 0 mA, C1 = C2 = 47 nF, CCP = 2.2 $\mu$ F	VB + 13	VB + 14	VB + 15	٧
V <sub>chv2_1</sub>	Output voltage	VB = 12 V, $I_{load}$ = 11 mA, C1 = C2 = 47 nF, CCP = 2.2 $\mu$ F	VB + 13	VB + 14	VB + 15	V
V <sub>chv2_2</sub>		VB = 12 V, $I_{load}$ = 18 mA, C1 = C2 = 47 nF, CCP = 2.2 $\mu$ F	VB + 12.5	VB + 13.5	VB + 15	V
V <sub>chv3_0</sub>		VB = 18 V, $I_{load}$ = 0 mA, C1 = C2 = 47 nF, CCP = 2.2 $\mu$ F	VB + 13	VB + 14	VB + 15	V
V <sub>chv3_1</sub>		VB = 18 V, $I_{load}$ = 13 mA, C1 = C2 = 47 nF, CCP = 2.2 $\mu$ F	VB + 13	VB + 14	VB + 15	V
V <sub>chv3_2</sub>		VB = 18 V, $I_{load}$ = 22 mA, C1 = C2 = 47 nF, CCP = 2.2 $\mu$ F	VB + 13	VB + 14	VB + 15	V
V <sub>chvmax</sub>	Maximum voltage		35	37.5	40	V
$V_{chvUV}$	Undervoltage detection threshold		VB + 4	VB + 4.5	VB + 5	V
T <sub>chv</sub> <sup>(1)</sup>	Rise time	VB = 5.3 V, C1 = C2 = 47 nF, CCP = 2.2 $\mu$ F, V <sub>chvUV</sub> released		1	2	ms
R <sub>on</sub>	On resistance S1~S4			8		Ω
HIGH SIDE	PRE-DRIVER					
V <sub>OH_H</sub>	Output voltage high	$I_{sink}$ = 10 mA, U(V/W)H – GFB	$V_{chv} - 2.7$	$V_{chv} - 1.35$		V
V <sub>OL_H</sub>	Output voltage low	$I_{\text{source}} = 10 \text{ mA}, U(V/W)H - GFB$		60	120	mV
R <sub>ONH_HP</sub>	ON resistance pull up (Pch)	U(V/W)H = PDCPV - 1 V		135	270	Ω
R <sub>ONH_HN</sub>	ON resistance pull up (Nch)	U(V/W)H = PDCPV - 2.5 V		8	16	Ω
R <sub>ONL_H</sub>	ON resistance pull down			6	12	Ω
Γ <sub>on_h</sub> <sup>(1)</sup>	Turn-on time	$VB = 5.3 \sim 18 \text{ V}, C_L = 11 \text{ nF}, R_L = 0$ Ω from 20% to 80%	100	300	500	ns
Γ <sub>off_h</sub> <sup>(1)</sup>	Turn-off time	VB = 5.3 ~ 18 V, $C_L$ = 11 nF, $R_L$ = 0 $\Omega$ from 80% to 20%	100	300	500	ns
Γ <sub>h-ondly</sub> <sup>(1)</sup>	Output delay time	$VB = 5.3 \sim 18 \ V, \ C_L = 11 \ nF, \ R_L = 0$ $\Omega$ to 20%, see Figure 7	100	200	400	ns
Γ <sub>h-offdly</sub> <sup>(1)</sup>	Output delay time	$\begin{array}{l} \text{VB = 5.3} \sim \text{18 V, C}_{\text{L}} = \text{11 nF, R}_{\text{L}} = 0 \\ \Omega \text{ to 80\%,} \\ \text{see Figure 7} \end{array}$	100	200	400	ns
OW SIDE	PRE-DRIVER					
√ <sub>OH_L</sub>	Output voltage high	$I_{sink} = 10 \text{ mA}, U(V/W)L - GFB$	VB - 0.14	VB-0.07		V
V <sub>OL_L</sub>	Output voltage low	$I_{source} = 10 \text{ mA}, U(V/W)L - GFB$		70	140	mV
R <sub>ONH_L</sub>	ON resistance pull up			7	14	Ω
R <sub>ONL_L</sub>	ON resistance pull down			7	14	Ω
T <sub>on_l</sub> <sup>(1)</sup>	Turn-on time	$VB = 5.3 \sim 18 \text{ V}, C_L = 22 \text{ nF}, R_L = 0$ Ω from 20% to 80%	100	300	800	ns
Γ <sub>off_I</sub> <sup>(1)</sup>	Turn-off time	$VB = 5.3 \sim 18 \text{ V}, C_L = 22 \text{ nF}, R_L = 0$ Ω from 80% to 20%	100	300	800	ns

Product Folder Links: DRV3202-Q1



# **Electrical Characteristics (continued)**

VB = 12 V,  $T_A = -40$ °C to 125°C (unless otherwise specified)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
T <sub>I-ondly</sub> (1)	Output delay time	$VB = 5.3 \sim 18 \text{ V, C}_L = 22 \text{ nF, R}_L = 0$ $\Omega$ to 20%, see Figure 7	100	200	400	ns
T <sub>I-offdly</sub> (1)	Output delay time	$VB = 5.3 \sim 18 \text{ V}, C_L = 22 \text{ nF}, R_L = 0$ $\Omega$ to 80%, see Figure 7	100	200	400	ns
V <sub>CLAMP</sub>	VGS protection voltage	-	16	18	20	V
T <sub>diff1</sub> (1)	Differential time 1	VB = $5.3 \sim 18$ V ( $T_{h-on}$ )–( $T_{l-off}$ ), see Figure 7	-300		300	ns
T <sub>diff2</sub> <sup>(1)</sup>	Differential time 2	VB = $5.3 \sim 18$ V ( $T_{l-on}$ )–( $T_{h-off}$ ), see Figure 7	-300		300	ns
PHASE C	OMPARATOR					
$V_{\text{iofs}}$	Input offset voltage		-15	_	15	mV
$V_{inp}$	Input voltage range (PHTM)	VB = 5.3 ~18 V	1.325	-	4.5	V
$V_{\text{inm}}$	Input voltage range (PHxM)		-1	_	VB	V
$V_{\text{ihys}}$	Input hysteresis voltage		100	200	400	mV
$V_{OH}$	Output high voltage	$I_{sink} = 2.5 \text{ mA}$	0.9 × V <sub>CC</sub>	_	_	V
$V_{OL}$	Output low voltage	I <sub>source</sub> = 2.5 mA	_	_	$0.1 \times V_{CC}$	V
T <sub>res_tr</sub> <sup>(1)</sup>	Response time (rising)	C <sub>L</sub> = 100 pF	_	0.2	0.5	μs
T <sub>res_tf</sub> <sup>(1)</sup>	Response time (falling)	C <sub>L</sub> = 100 pF	_	0.4	1	μs
MOTOR C	CURRENT SENSE <sup>(2)</sup>					
V <sub>Ofs</sub>	Input offset voltage		-5		5	mV
V <sub>O_0</sub>	Output voltage (ALV)	VB = 5.3 ~ 18 V, I <sub>motor</sub> = 0 A		1		V
$V_{Line}$	Linearity (ALV)	$VB = 5.3 \sim 18 \text{ V},$ $R_{shunt} = 1 \text{ m}\Omega,$ $R11 = R12 = 1 \text{ k}\Omega, R21 = R22 = 30$ $R11 = R12 = R22 = R$	-2%	30	2%	mV/A
$V_{Gain}$	Gain		10		30	
T <sub>set_TR1</sub>	Settling time (Rise) ALV ±1%	VB = 5.3 ~ 18 V, R <sub>shunt</sub> = 1 mΩ, C1 = 4.7 pF, C <sub>L</sub> = 100 pF, R11 = R12 = 1 kΩ, R21 = R22 = 30 kΩ, I <sub>motor</sub> = 0 → 30 A, (ALV : 1→1.9 V)	-	1	2.5	μs
T <sub>set_TR2</sub>	Settling time (Rise) ALV ±1%	$VB = 5.3 \sim 18 \text{ V},$ $R_{shunt} = 1 \text{ m}\Omega, \text{ C1} = 4.7 \text{ pF}, \text{ C}_L = 100 \text{ pF},$ $R11 = R12 = 1 \text{ k}\Omega, \text{ R21} = R22 = 30 \text{ k}\Omega,$ $I_{motor} = 0 \rightarrow 100 \text{ A}, \text{ (ALV : 1} \rightarrow 4 \text{ V})$	-	1	2.5	μѕ
T <sub>set_TF1</sub>	Settling time (Fall) ALV ±1%	$VB = 5.3 \sim 18 \text{ V},$ $R_{shunt} = 1 \text{ m}\Omega, \text{ C1} = 4.7 \text{ pF}, \text{ C}_L = 100 \text{ pF},$ $R11 = R12 = 1 \text{ k}\Omega, \text{ R21} = R22 = 30 \text{ k}\Omega,$ $I_{motor} = 30 \rightarrow 0 \text{ A}, \text{ (ALV : 1.9} \rightarrow 1 \text{ V)}$	-	1	2.5	μѕ
T <sub>set_TF2</sub>	Settling time (Fall) ALV ±1%	VB = 5.3 ~ 18 V, $R_{shunt}$ = 1 mΩ, C1 = 4.7 pF, C <sub>L</sub> = 100 pF, R11 = R12 = 1 kΩ, R21 = R22 = 30 kΩ, $I_{motor}$ = 100 $\rightarrow$ 0 A, (ALV : 4 $\rightarrow$ 1 V)	-	1	2.5	μs

# (2) Motor current is converted to voltage in test

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# **Electrical Characteristics (continued)**

VB = 12 V,  $T_A = -40$ °C to 125°C (unless otherwise specified)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OVAD	Overcurrent threshold	150-A detection, $R_{shunt}=1~m\Omega,$ $R11=R12=1~k\Omega,~R21=R22=30~k\Omega,$ $R3=8.2~k\Omega,~R4=10~k\Omega$	-10%	150	10%	A
TDEL_OV AD <sup>(1)</sup>	Propagation delay (Rise or fall)		_	-	1.5	μs
PHASE AM	PLIFIER					
$V_{ofs\_SH}$	Output offset voltage, sample and hold mode	VB = 5.3–18 V, Gain = 1	-50	-	50	mV
$V_{ofs\_TH}$	Output offset voltage, through mode	VB = 5.3–18 V, Gain = 1	-50	_	50	mV
V <sub>in_cm</sub>	Common mode input range	VB = 5.3–18 V, Gain = 1–4	1.5		VB – 1.5	V
V <sub>out_max</sub>	Maximum output voltage	VB = 5.3–18 V, Gain = 1–4	4.5	_	_	V
V <sub>out_min</sub>	Minimum output voltage	VB = 5.3–18 V, Gain = 1–4	-	_	0.5	V
V <sub>gain</sub> <sup>(3)</sup>	Gain		-	1 2 3 4	-	
V <sub>out_SH0</sub>	Output voltage, sample and hold mode	VB = 5.3–18 V, Gain = 1–4, PHxT = VB / 2	_	2.5	-	V
V <sub>out_TH0</sub>	Output voltage, through mode	VB = 5.3–18 V, Gain = 1–4 PHxT = VB / 2	_	2.5	-	٧
V <sub>out_SH1</sub>	Output voltage, sample and hold mode	VB = 12 V, Gain = 1, PHxT = 1.5 V	_	1.375	-	V
V <sub>out_TH1</sub>	Output voltage, through mode	VB = 12 V, Gain = 1, PHxT = 1.5 V	-	1.375	-	V
V <sub>out_SH2</sub>	Output voltage, sample and hold mode	VB = 12 V, Gain = 1, PHxT = 10.5 V	_	3.625	-	V
V <sub>out_TH2</sub>	Output voltage, through mode	VB = 12 V, Gain = 1, PHxT = 10.5 V	-	3.625	-	V
STL_SHT R	Settling time (rise), sample and hold mode PTVx ±1%	VB = 12 V, Gain = 1, PSC = 470 pF, PTVx = 100 pF, PHxT = 1.5 V ≥ 10.5 V, (PTVx = 1.375 V → 3.625 V), see Figure 12		1.5	3	μs
STL_THT R	Settling time (rise), through mode PTVx ±1%	VB = 12 V, Gain = 1, PTVx = 100 pF, PHxT = 1.5 V ≥ 10.5 V, (PTVx = 1.375 V $\rightarrow$ 3.625 V), see Figure 13		1.5	3	μs
STL_SHT F	Settling time (fall), sample and hold mode PTVx ±1%	VB = 12 V, Gain = 1, PSC = 470 pF, PTVx = 100 pF, PHxT = 10.5 V ≥ 1.5 V, (PTVx = 3.625 V → 1.375 V), see Figure 12		1.5	3	μs
STL_THTF	Settling time (fall), through mode PTVx ±1%	VB = 12 V, Gain = 1, PTVx = 100 pF, PHxT = 10.5 V ≥ 1.5V, (PTVx = 3.625 V $\rightarrow$ 1.375 V), see Figure 13		1.5	3	μs
SH Error Voltage	Falling voltage	VB = 5.3–18 V, PSC = 470 pF, TH = 1 mS, see Figure 11		5	75	mV
V <sub>CC</sub>						
V <sub>CC</sub>	Output voltage	VB = 5.3–18 V, I <sub>load</sub> = 5–150 mA	4.9	5	5.1	V
IBVCC	Base current		1.5			mA
hfePNP	DC current gain of external VCC		100	-		<del></del>

## (3) $V_{gain}$ is an SPI setting

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# **Electrical Characteristics (continued)**

VB = 12 V,  $T_A = -40$ °C to 125°C (unless otherwise specified)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
VLRVCC	Load regulation	$VB = 5.3-18 \text{ V}, I_{load} = 5-150 \text{ mA}$	-50	-	50	mV
CVCC	Load capacitance		22		100	μF
RVCC	ESR of external capacitance				300	$m\Omega$
VCCUV	Undervoltage detection threshold	R1 = 7.5 k $\Omega$ , R2 = 10 k $\Omega$ , VCCUV > 4 V	3.97	4.07	4.17	V
VCCUVHY S	Undervoltage detection threshold hysteresis			100		mV
VCCOV	Overvoltage detection threshold		6	6.5	7	V
ICLVCC	Current limit	$R_{sns} = 0.51 \Omega$	300	400	550	mA
TVCC1	Rise time	V <sub>CC</sub> > UVVCC, CVCC = 22 μF		0.3	0.5	ms
TVCC2	Rise time	V <sub>CC</sub> > UVVCC, CVCC = 100 μF		1	1.5	ms
$V_{DD}$						
$V_{DD}$	Output voltage	VB = 5.3–18 V, I <sub>load</sub> = 0–2 mA	3	3.3	3.6	V
CVDD	Load capacitance			1		μF
VDDUV	Undervoltage detection threshold		2.2	2.3	2.4	V
VDDOV	Overvoltage detection threshold		4.1	4.3	4.5	V
T <sub>vdd</sub> <sup>(1)</sup>	Rise time	$V_{DD} > VDDUV$ , $CVDD = 1 \mu F$		75	150	μs
VB MONITO	DR .					
$V_{stop}$	Pre-driver stop VB voltage		26.5	27.5	28.5	V
THERMAL	SHUT DOWN					
TSD <sup>(1)</sup>	Thermal shut down threshold		155	175	195	°C
OSCILLATO	OR .					
OSC	OSC frequency		9	10	11	MHz
INPUT BUF	FER 1					
$V_{IH}$	Input threshold logic high		$0.7 \times V_{CC}$			V
$V_{IL}$	Input threshold logic low				$0.3 \times V_{CC}$	V
$R_{u}$	Input pullup resistance		50	100	150	kΩ
R <sub>u</sub> (CAN_TX)	Input pullup resistance		12.5	25	37.5	kΩ
R <sub>d</sub>	Input pulldown resistance		50	100	150	kΩ
OUTPUT B	UFFER 1 AND 2					
V <sub>OH</sub>	Output level logic high	I <sub>sink</sub> = 2.5 mA	0.9 × V <sub>CC</sub>			V
V <sub>OL</sub>	Output level logic low	I <sub>source</sub> = 2.5 mA			0.1 × V <sub>CC</sub>	V
OUTPUT B	UFFER 3					
R_RES	Pullup resistor		1.5	3	4.5	kΩ
V <sub>OL</sub>	Output level logic low	I <sub>source</sub> = 2 mA			0.1 × V <sub>CC</sub>	V

# 6.5 Supply Voltage and Current

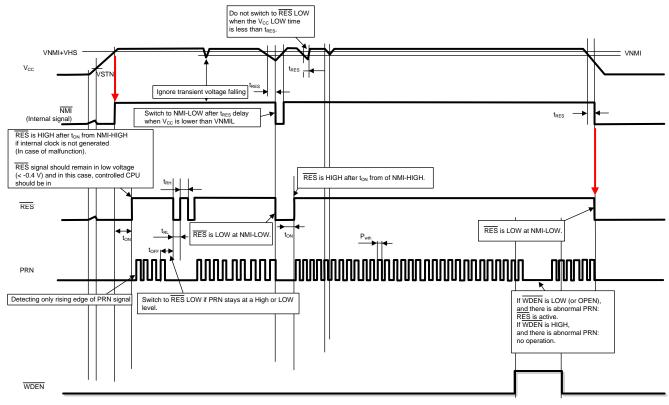
VB = 12 V,  $T_A = -40$ °C to 125°C (unless otherwise specified)

	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
SUPP	PLY INPUT					
VB	VB Supply voltage		5.3	12	18	V
$I_{VB}$	VB Operating current	VB = 5.3 ~18 V, CAN_TX = High, No PWM		20	35	mA

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NOTE:  $\overline{\text{WDEN}} = \text{High}$ ,  $V_{CC}$  undervoltage condition sets  $\overline{\text{RES}} = \text{Low}$ 

Figure 1. Watchdog Timing Chart

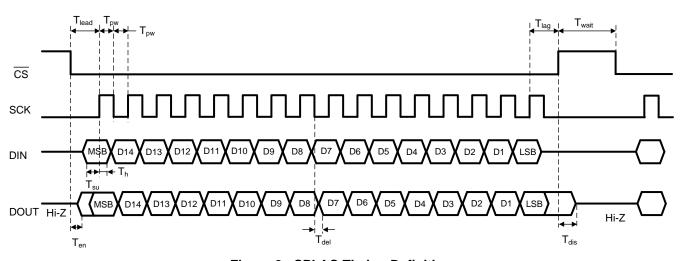


Figure 2. SPI AC Timing Definition

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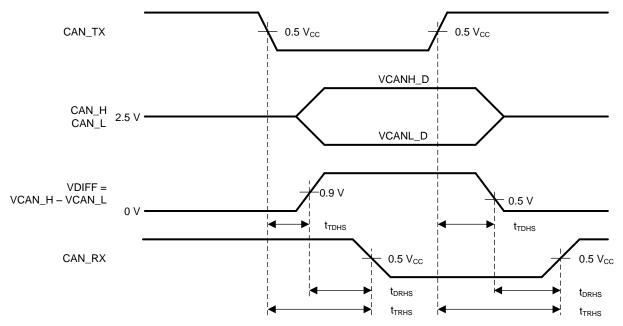
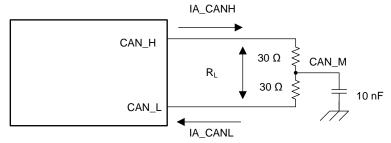


Figure 3. CAN Timing Chart



Test circuit for measurement of AC characteristics and slew rate.

NOTE: If CAN\_L is shorted to GND, try to keep transmission (no overcurrent event).

Figure 4. CAN Testing Condition

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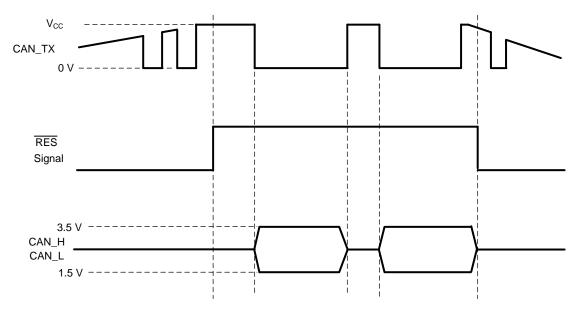


Figure 5. CAN Reset Function

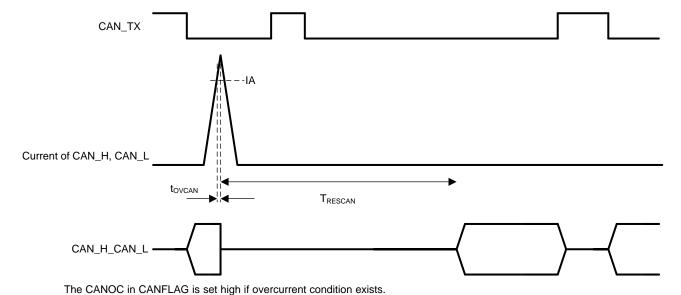


Figure 6. Overcurrent Event

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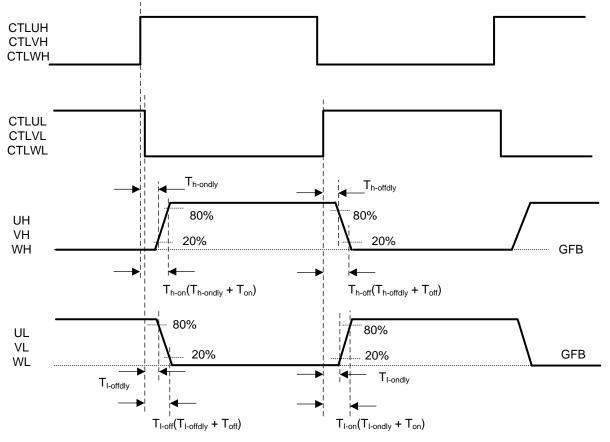


Figure 7. Delay Time from Input to Output

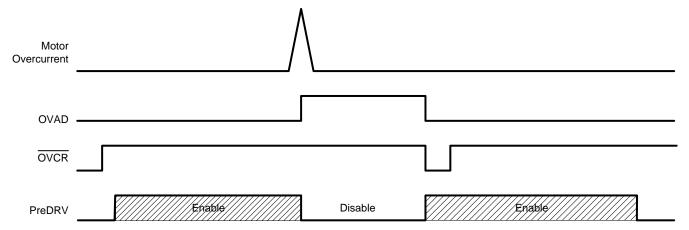


Figure 8. Motor Overcurrent Event

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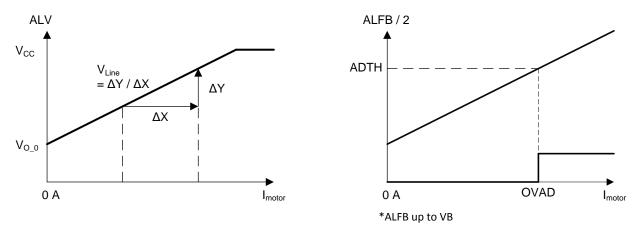


Figure 9. Motor Current Sense and Overcurrent

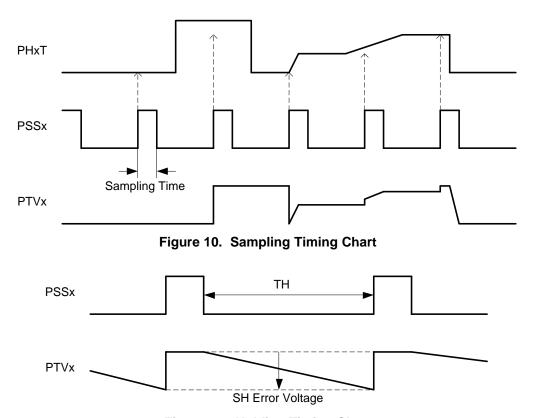


Figure 11. Holding Timing Chart



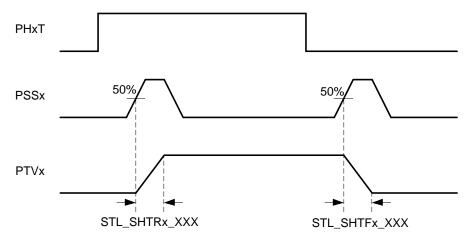


Figure 12. Settling Time Timing Chart (Sample and Hold Mode)

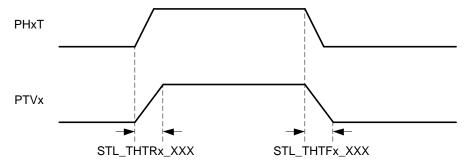


Figure 13. Settling Time Timing Chart (Through Mode)

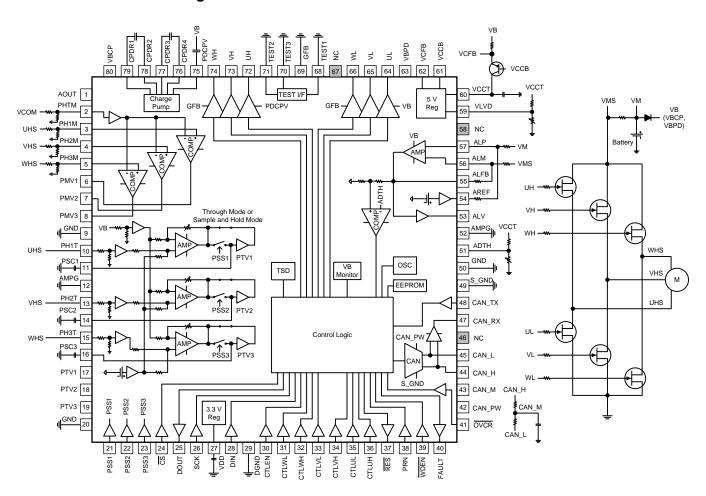
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# **Detailed Description**

## 7.1 Functional Block Diagram



# 7.2 Feature Description

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# 7.2.1 Watchdog

The watchdog monitors the PRN signal and  $V_{CC}$  supply level and generates a reset to the MCU through the  $\overline{RES}$  pin if the status of the PRN is not normal or the  $V_{CC}$  is lower than the specified threshold level. The watchdog can be disabled if WDEN is set high.



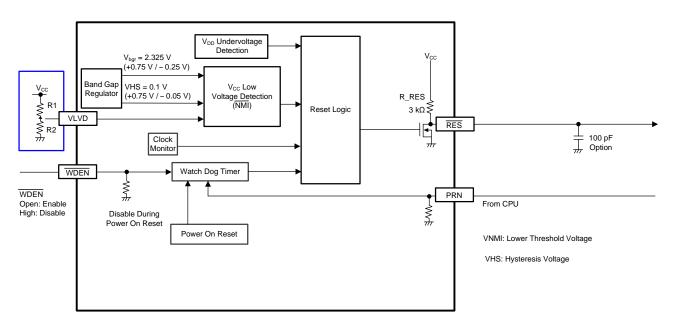


Figure 14. Watchdog Block Diagram

### 7.2.2 Serial Port I/F

The SPI is used to receive an input byte from CPU and to transmit an output byte to CPU. Four signals are utilized according to the timing chart of Figure 15.

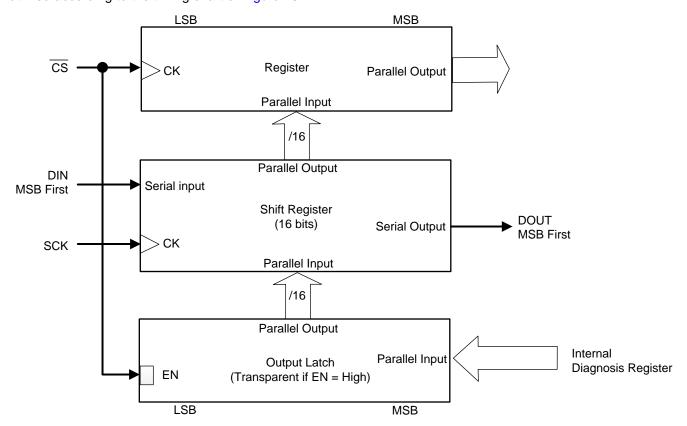


Figure 15. Block Diagram of SPI

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# **Feature Description (continued)**

### CS – Chip Select

- This input signal is utilized to select this IC by CPU.
- This input signal is normally high and the communication is possible only when it is forced low.
- When this input signal falls, the communication between this IC and the CPU starts.
- Transmitted data is latched and the DOUT pin comes out of high impedance.
- When this input signal rises, the communication stops.
- The DOUT pin goes into high impedance. Then, the internal input register updates with the received bits (only if the clock pulse numbers are right and the key bit of the DIN signals is correct).
- The next falling edge starts another communication.
- There is a minimum waiting time between two communications (T<sub>wait</sub>).
- The pin has an internal pullup.

### SCK – Synchronization Serial Clock

- This input signal is utilized to synchronize the communication by CPU.
- It is normally high and the correct clock pulse number is 16.
- At each falling edge, the CPU writes a new bit on the DIN input and this IC writes a new bit on the DOUT pin. At each rising edge, this IC reads the new bit on the DIN pin and the CPU reads the new bit on the DOUT pin.
- The maximum clock frequency is 4 MHz.
- The pin has an internal pullup.

### DIN – Serial Input Data

- This input signal is used to receive 16-bit data.
- The bits are received in order from the MSB (first) to the LSB (last).
- The pin has an internal pullup.

### DOUT – Serial Output Data

- This output signal is used to transmit 16-bit data.
- It is a 3-state output and it is in high impedance mode when \$\overline{CS}\$ is high.
- The serial data bits are transmitted in order from the MSB (first) to the LSB (last).

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#### 7.2.3 CAN

The CAN data from CAN control logic is transmitted to other systems through the CAN bus. The receiver compares the CAN\_H\_CAN\_L voltage levels against an internally generated reference and the result is output through CAN\_TX. It has overcurrent protection, shown in Figure 6.

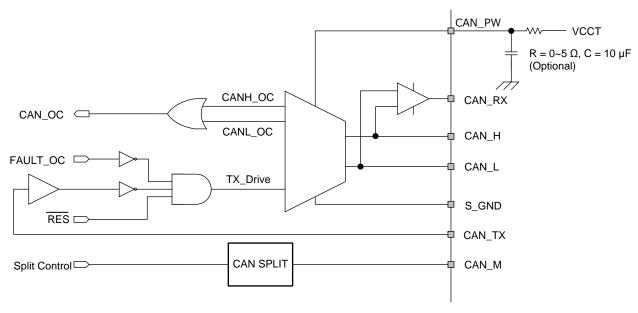


Figure 16. CAN Block Diagram

### 7.2.4 Charge Pump

The charge pump block generates the supply for high-side and low-side pre-drivers to maintain the gate voltage on the external FETs. External storage cap (CCP) and bucket caps (C1, C2) are used to support pre-driver slope and switching frequency requirements. R1 and R2 can reduce switching current if required. The charge pump has a voltage supervisor for over and undervoltage, and a selectable stop condition for pre-drivers.

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## **Feature Description (continued)**

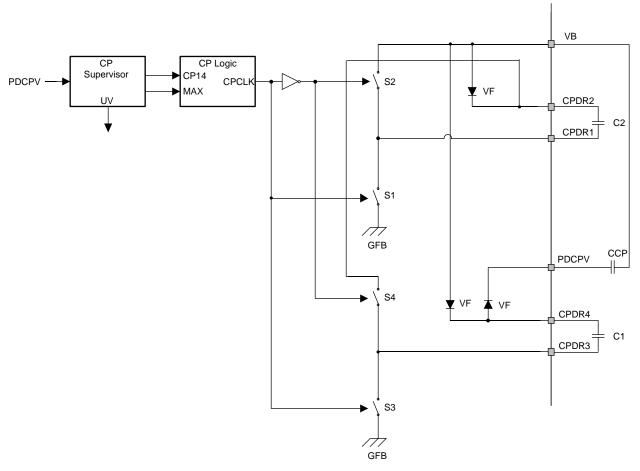


Figure 17. Charge Pump Block Diagram

#### 7.2.5 Pre-Driver

The pre-driver block provides three high-side pre-drivers and three low-side pre-drivers to drive external N-channel MOSFETs. The turn on side of the high-side pre-drivers supply the large N-channel transistor current to quickly charge and PMOS support output voltage up to PDCPV. The turn off side supplies the large N-channel transistor current to quickly discharge, while the low-side pre-drivers supply the large N-channel transistor current for charge and discharge. The output voltage of the low-side pre-driver is controlled by VB and it has VGS protection to make less than 18 V. The pre-driver has a stop condition in some fault conditions (\$16 Error Detection).



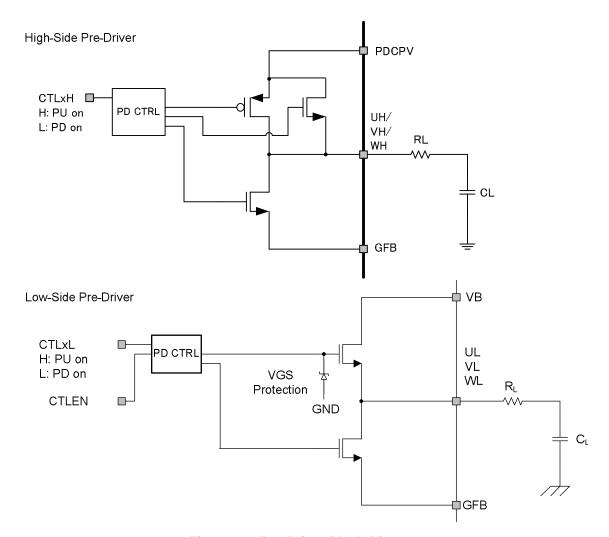


Figure 18. Pre-Driver Block Diagram

### 7.2.6 Phase Comparator

A 3-channel comparator module monitors the external FET by detecting voltage across the drain-source for high-side and low-side FETs. PHTM is the threshold level of comparators usable for sensorless communication. Figure 19 shows an example of the threshold level. There is no detection when CTLEN = Low.

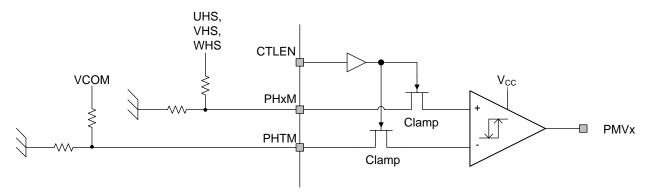


Figure 19. Phase Comparator Block Diagram

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## **Feature Description (continued)**

#### 7.2.7 Motor Current Sense

The operational amplifier is operating with an external resistor network for higher flexibility to adjust the current measurement to application requirements. The first stage amplifier is operating with the external resistor and the output voltage up to VB at ALFB. The gain of the amplifier is adjustable by external resistors from x10 to x30. The second stage amplifier is a buffer to MCU at ALV. Current sense has a comparator for motor overcurrent (OVAD). ADTH is the overcurrent threshold level and sets the value by the external resistor as well. Figure 9 shows the curve of the detection level. ALFB is divided by 2, compare this value with ADTH. In the recommended application, zero-point adjustment is required as a large error offset in the initial condition.

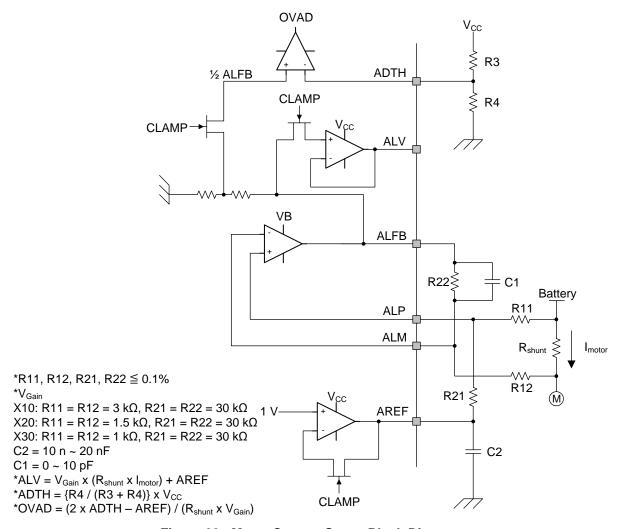


Figure 20. Motor Current Sense Block Diagram

### 7.2.8 Phase Amplifier (Sample and Hold Mode and Through Mode)

The 3-channel amplifier module monitors the drain-source for high-side and low-side FETs. Two modes (selected by the SPI) are provided: sample and hold mode, and through mode. Sample and hold is controlled by PSSx at the external pins and PSCx connects the charging capacitor. Through mode is real-time detection and the amplifier has x1–x4 gain control.

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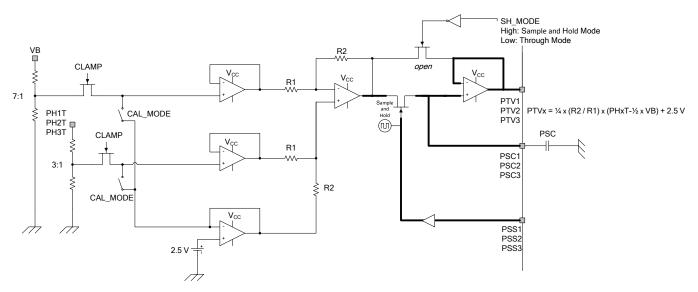


Figure 21. Sample and Hold Mode Block Diagram

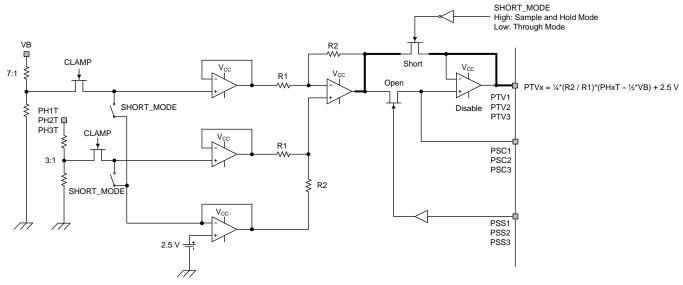


Figure 22. Through Mode Block Diagram

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## **Feature Description (continued)**

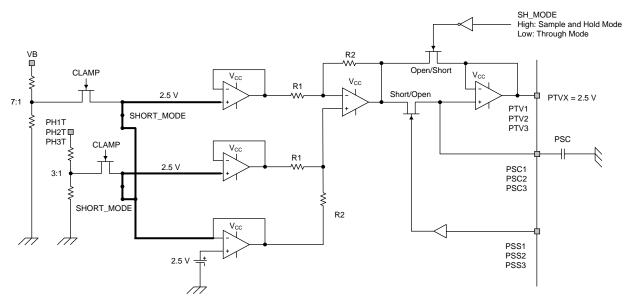


Figure 23. Short Mode (Optional) Block Diagram

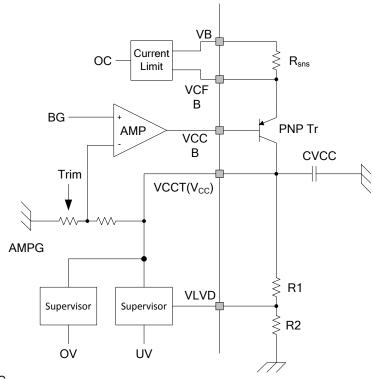
# 7.2.9 Regulators

The regulator block offers a 5-V LDO and a 3.3-V LDO. The  $V_{CC}$  LDO regulates VB down to 5 V with an external PNP controlled by the regulator block. The 5-V LDO is supplied to the MCU and other components. The 5-V LDO is protected against a short to GND fault, and the external resistors R1 and R2 set the undervoltage. The  $V_{DD}$  regulator regulates VB down to 3.3-V with an internal FET and a controller.

The regulators detect the overvoltage and undervoltage events of both supplies.

Product Folder Links: DRV3202-Q1





- \* R<sub>sns</sub> = 0.2 V / ICLVCC \* VCCUV = 2.325 x {(R1+R2) / R2}

Figure 24. V<sub>CC</sub> Block Diagram

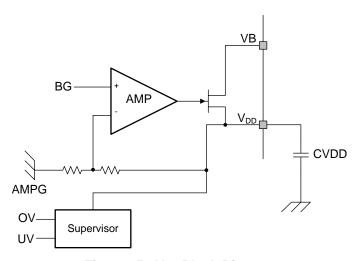


Figure 25. V<sub>DD</sub> Block Diagram

### 7.2.10 VB Monitor

The block monitors VB overvoltage.



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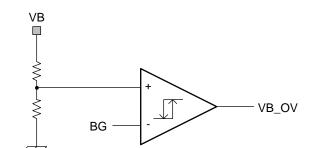


Figure 26. VB Monitor Block Diagram

### 7.2.11 Thermal Shutdown

The device has temperature sensors that produce a pre-driver stop condition if the chip temperature exceeds 175°.

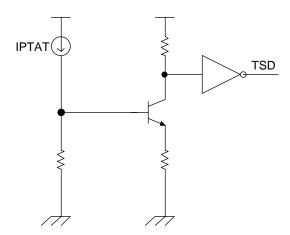


Figure 27. Thermal Shutdown Block Diagram

### 7.2.12 Oscillator

Oscillator block generates two 10-MHZ clock signals. OSC1 is the main clock used for internal logic synchronization and timing control. OSC2 is the secondary clock which is used to monitor the status of OSC1.

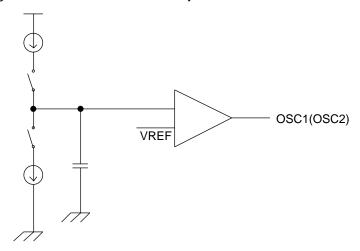


Figure 28. Oscillator Block Diagram

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### 7.2.13 I/O

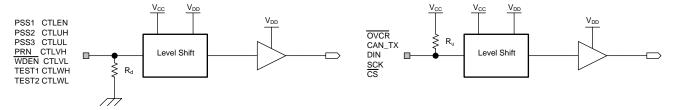


Figure 29. Input Buffer 1 Block Diagram

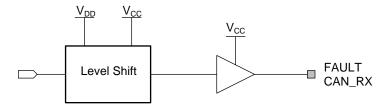


Figure 30. Output Buffer 1 Block Diagram

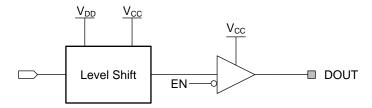


Figure 31. Output Buffer 2 Block Diagram

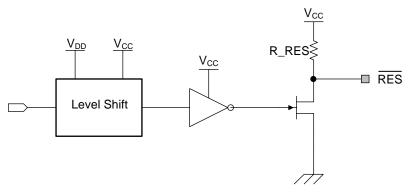


Figure 32. Output Buffer 3 Block Diagram

## 7.2.14 Error Detection

**Table 1. Error Detection** 

ITEMS	SPI	PRE-DRIVER	FAULT SIGNAL	RES
VB – Overvoltage	_	STOP	L	Н
CP – Overvoltage	_	STOP	L	П
CP – Undervoltage	Error Bit (CPLV)	-	L	Н
V <sub>CC</sub> – Overvoltage	Error Bit (VCO)	-	L	Н
V <sub>CC</sub> – Undervoltage	-	STOP	L	L

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**Table 1. Error Detection (continued)** 

ITEMS	SPI	PRE-DRIVER	FAULT SIGNAL	RES
V <sub>CC</sub> – Overcurrent	Error Bit (V <sub>CC</sub> )	_	Н	Н
Motor – Overcurrent	Error Bit (OVAD)	STOP	Н	Н
V <sub>DD</sub> – Overvoltage	Error Bit (VDO)	_	L	Н
V <sub>DD</sub> – Undervoltage	_	STOP	L	L
Thermal Shut Down	Error Bit (TD)	STOP	Н	Н
Watchdog	-	_	L	L
EEPROM Data Check	Error Bit (EEP)	_	L	Н
Clock Monitor	_	_	L	L
CAN Overcurrent	Error Bit (CCD)	_	L	Н
SPI	Error Bit (SPI)	_	L	Н

### 7.3 Device Functional Modes

**Table 2. Motor Overcurrent Truth Table** 

RES	OVCR	MOTOR OVERCURRENT	OVAD	PRE-DRIVER ENABLE OR DISABLE
0	_		0 (Clear)	Disable <sup>(1)</sup>
1	0	ŀ	0 (Clear) (2) (3)	Enable
	1	0	Keep	Enable
		1	1 (Set)	Disable

- (1) The CTLEN goes to Hi-Z because the external CPU will not drive it when RES = 0, then all the pre-drivers are turned off because CTLEN is internally pulled down.
- (2) The OVAD is not set, even if a motor overcurrent error is generated during  $\overline{\text{OVCR}} = 0$ .
- (3) The OVAD is cleared if OVCR = 0 even when the motor overcurrent error is generated.

## 7.4 Register Maps

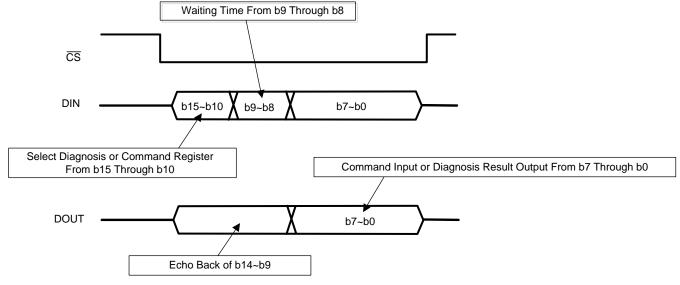


Figure 33. SPI Bit Sequence

Table 3. SPI Bit Map (DIN)

ITEM	B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
COMMAND1	0	0	0	0	0	1	-	-	SHM	SRT	-	-	-	-	-	-
COMMAND2	0	0	0	0	1	0	-	-	AG1	AG0	-	-	-	-	-	-
COMMAND3	0	0	0	0	1	1	-	-	-	-	1	ı	-	ı	-	_

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# **Register Maps (continued)**

### Table 3. SPI Bit Map (DIN) (continued)

ITEM	B15	B14	B13	B12	B11	B10	В9	B8	В7	В6	B5	B4	В3	B2	B1	В0
DIAG_READ1	0	0	1	0	0	0	-	-	-	-	-	-	-	-	-	-
DIAG_READ2	0	1	0	0	0	0	-	-	-	-	-	-	-	-	_	-
DIAG_READ3	0	1	1	0	0	0	-	-	-	-	-	-	-	-	-	-

In Table 3, the B15-B10 are the control bits, so the each command depends on them (listed below).

#### 1. B15-B10 = 0 0 0 0 0 1

These are the commands:

- 1) Phase AMP Sampling Hold Mode (B7 bit)
  - 0: OFF (through) (INITIAL VALUE)
  - 1: ON (use sample hold mode)
- 2) Phase AMP Short Mode [Short\_Mode] (B6 bit)
  - 0: OFF (no calibration) (INITIAL VALUE)
  - 1: ON (use calibration mode)

### 2. **B15-B10 = 0 0 0 0 1 0**

These are the commands:

- 1) Phase AMP Gain (B7 bit and B6 bit)
  - B7:0 B6:0; Gain x1 (INITIAL VALUE)
  - B7:0 B6:1; Gain x2
  - B7:1 B6:0; Gain x3
  - B7:1 B6:1; Gain x4

#### 3. B15-B10 = 000011

Not used

#### 4. B15-B10 = 0 0 1 0 0 0

This command is to read the diagnosis of the current regulator,

SPI communication, overvoltage detection, and input diagnosis.

### 5. **B15-B10 = 0 1 0 0 0 0**

This command is to read the diagnosis of SPI communication.

### 6. **B15-B10 = 0 1 1 0 0 0**

Not used

### 7. B15-B10 = Other command

This command sets the SPI-NG (DOUT, B7) bit.

### Table 4. SPI Bit Map (DOUT)

ITEM	B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
ON/OFF COMMAND ECHO BACK	0	0	0	0	0	1	0	0	_	-	_	_	_	_	_	_
LOTIO BACK	0	0	0	0	0	1	1	0	-	-	-	-	-	-	-	-
DIAG_READ1	0	0	0	1	0	0	0	0	VCC	OCD	CCD	VCO	VDO	CPLV	TD	EEP
DIAG_READ2	0	0	1	0	0	0	0	0	SPI	-	-	-	-	-	-	-
DIAG_READ3	0	0	1	1	0	0	0	0	_	-	-	_	-	_	_	-

### 1. B14-B9 = 0 0 1 0 0 0

This flag is cleared after the register is read by the CPU.

## 1) V<sub>CC</sub> Current Detection (B7)

- 0: NORMAL
- 1: Fail (Short to GND or open)

### 2) Overcurrent Detection (B6)

- 0: NORMAL
- 1: Fail (Overcurrent)

### 3) CAN Current Detection (B5)

0: NORMAL

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- 1: Fail (Overcurrent)
- 4) V<sub>CC</sub> Overvoltage Detection (B4)
  - 0: NORMAL
  - 1: Fail (V<sub>CC</sub> overvoltage)
- 5) V<sub>DD</sub> Overvoltage Detection (B3)
  - 0: NORMAL
  - 1: Fail (V<sub>DD</sub> overvoltage)
- 6) CPV Low Voltage Detection (B2)
  - 0: NORMAL
  - 1: Fail (CPV low voltage)
- 7) Thermal Detection (B1)
  - 0: NORMAL
  - 1: Fail (Overtemperature)
- 8) EEPROM\* Data Consistency Check (B0)
  - 0: NORMAL
  - 1: Fail (EEPROM DATA CRC error)
- \*ASIC calibration EEPROM

#### NOTE

Just after power-on of the IC, some of the bits listed above may be set depending on the apply sequence of VB. It is recommended to issue a DIAG\_READ1 to clear these bits prior to all S/W sequences.

#### 2. B14-B9 = 010000

This flag is cleared after the register is read by the CPU.

- 1) SPI-NG (B7)
  - 0: NORMAL
  - 1: Fail (SPI read and write command is wrong)

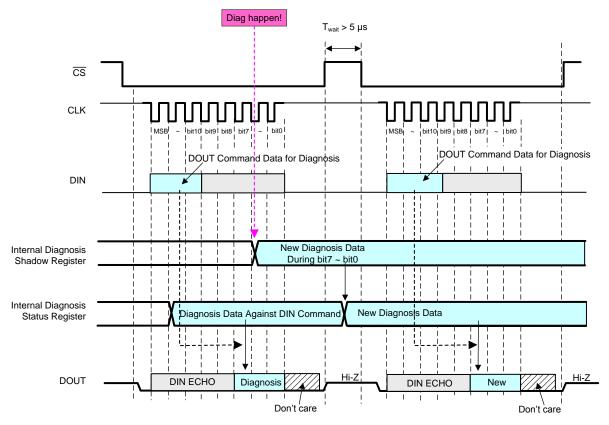


Figure 34. DIAG\_READ

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## 7.4.1 Internal Diagnosis Register (Status Register and Shadow Register)

If the diagnosis happens during the SPI communication, the function follows this protocol:

The diagnosis information is stored in the shadow register when the diagnosis happens.

After the output of the previous information a new diagnosis is sent from the shadow to the status register, and both registers are output through the DOUT pin.

In this case, a FAULT signal continues to be output until a new diagnosis is read by the CPU.

All diagnosis bits read by the DIAG\_READ1 command happen before the  $\overline{\text{CS}}$  falling edge. So, all the diagnosis events that happen right after the  $\overline{\text{CS}}$  falling edge are not read by the current DIAG\_READ1 command, instead they are read by the next DIAG\_READ1 command.

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# 8 Device and Documentation Support

### 8.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 8.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 8.3 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

### 8.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 8.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 9 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Product Folder Links: DRV3202-Q1



# PACKAGE OPTION ADDENDUM

27-Jun-2016

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
DRV3202QPFPQ1	NRND	HTQFP	PFP	80	96	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 125	DRV3202	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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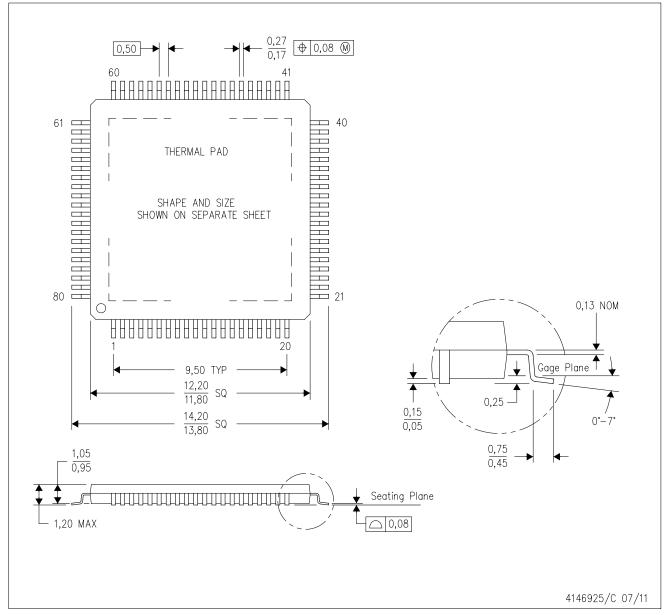




27-Jun-2016

PFP (S-PQFP-G80)

# PowerPAD™ PLASTIC QUAD FLATPACK



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com <a href="https://www.ti.com">www.ti.com</a>.
- E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
- F. Falls within JEDEC MS-026

### PowerPAD is a trademark of Texas Instruments.

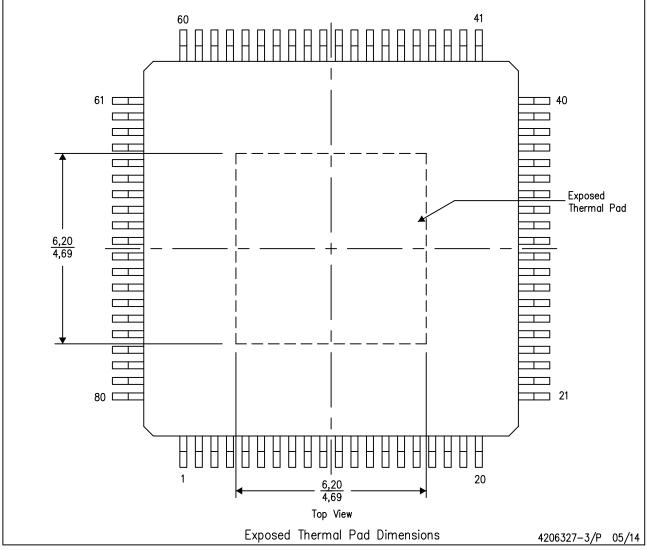


### THERMAL INFORMATION

This PowerPAD package incorporates an exposed thermal pad that is designed to be attached to a printed circuit board (PCB). The thermal pad must be soldered directly to the PCB. After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



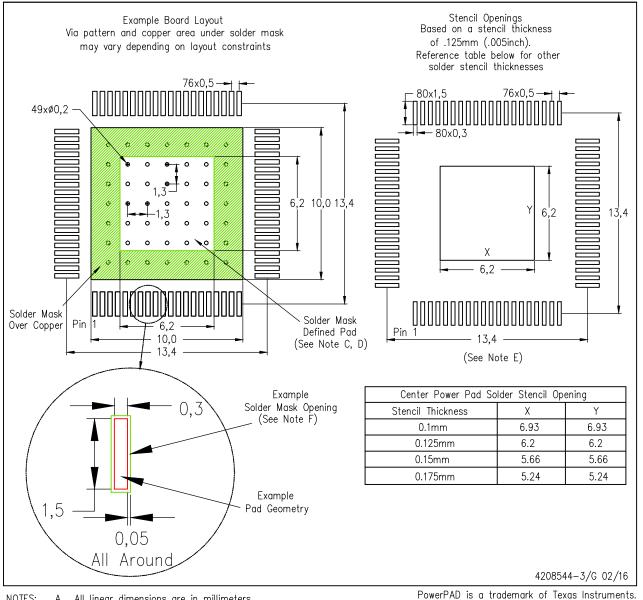
NOTE: A. All linear dimensions are in millimeters

PowerPAD is a trademark of Texas Instruments



# PFP (S-PQFP-G80)

# PowerPAD™ PLASTIC QUAD FLATPACK



NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002, SLMA004, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <a href="http://www.ti.com">www.ti.com</a>. Publication IPC-7351 is recommended for alternate designs.
- Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

  F. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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